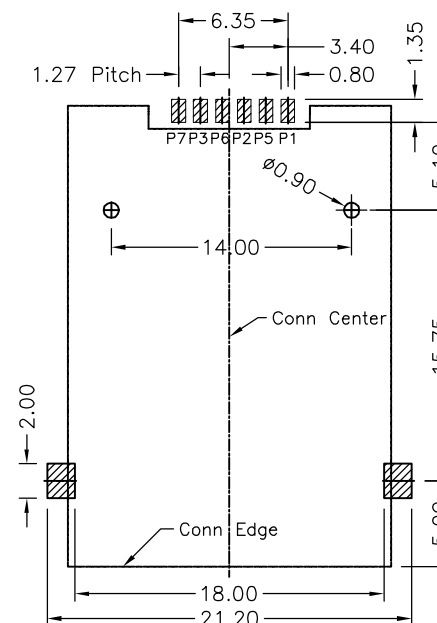
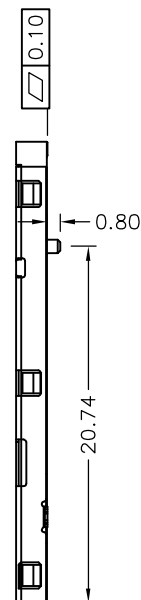
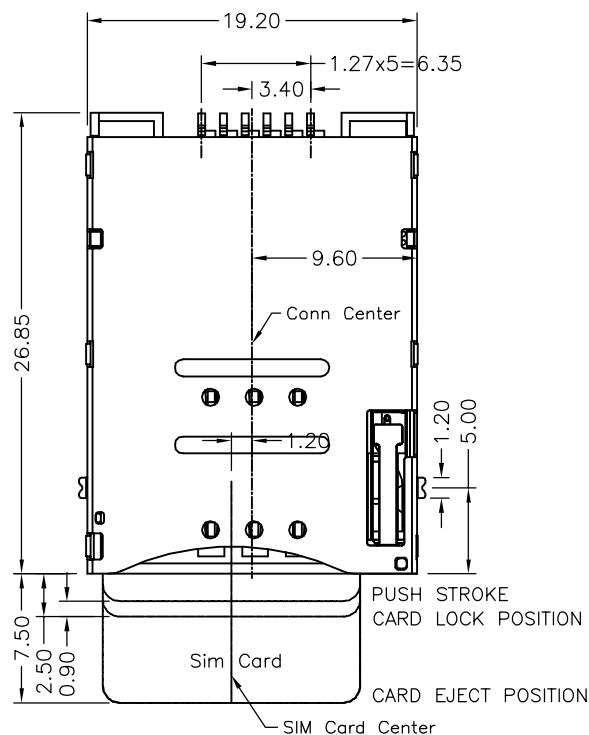


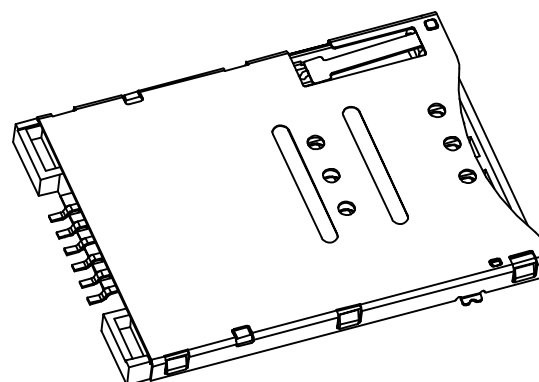
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2011/10/31



RECOMMENDED PCB LAYOUT
TOL:(±0.05)

Specification:

- *Electrical Characteristics:
Current Rating:0.5A.
Withstanding Voltage:AC500V r.m.s.
Insulation Resistance:1000Megohms Minimum at DC 500V
Contact Resistance:100Miliohms Maximum.
- *Mechanical Characteristics:
Mating Cycles:5000 Insertions.
- *Environmntal:
Operating Temperature:-40°To+60°
- *Material:
1.Housing:HI-Temp plastic UL 94V-0 Rated.
2.Contact:Copper Alloy.
3.Shell:SUS.
- *Finish :
3u" Gold plated on conatct area,100u"Min Tin plated on solder tails, Base Nickel :50u"Min
- *Packing:
Number of connectors:Pcs/REEL



GENERAL TOLERANCE		DWG NO.	A0423-01	APPD:	WIND	Scale	1:1
X.±0.45	x.'±5'	Title	SIM CARD PUSH PUSH	CHKD:		UNIT	mm
.X±0.35	.x'±2'			DR:			
.XX±0.25	.xx'±1'	Part NO.	ASMFS180B01BR008	Date	2012/02/29		
.XXX±0.15	.xxx'±0.5'						
SHEET	1/1						